LCC - Series LCC Sockets JEDEC Type "C"

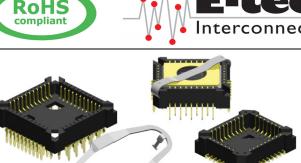
Production sockets for JEDEC Type "C" LCC chips.

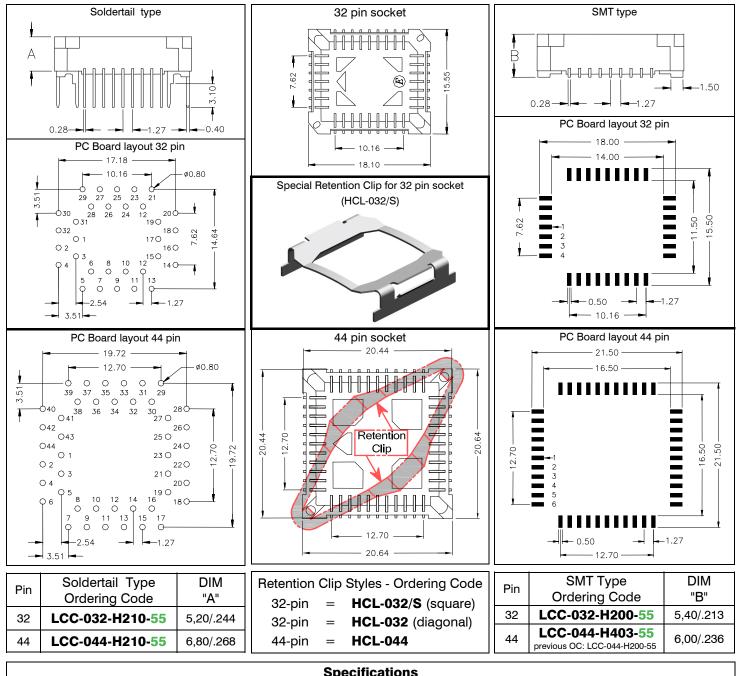
Socket design for automatic assembly and vacuum pick and place machines, available in soldertail and SMT version. In order to ensure compatibility with newer generation 44-pin LCC chip packages we have replaced the previous H200 contact style by new style H403. The previous generation 44-pin chip packages are also adapted to this new contact style.

The SMT terminals extend beyond the side of the socket body, which permits direct access of the infrared heat to the terminal, thus preventing an undesired heat exposure of the insulator. Optional retention clips are available, which can be mounted and

demounted without any tools.

Chips can be easily removed with the Universal extraction tool PUL-200.





Mechanical data

Contact material	(RoHS compliant)
Plating	

Insulator

(RoHS compliant)

Operating temperature Processing temperature BeCu Au over Ni over Cu (Sn on request) high temp plastic UL 94 V-0 -55°C to +125°C 250°C +0/-5°C for 20~40 Sec.

Specifications

Electrical data Insulation resistance at 500V DC Breakdown voltage at 60 Hz Contact resistance at 10 mA Capacitance Current rating Pitch

1000 MΩ min. 700V AC for one Minute 30 m Ω max. 1pF max. 1 A max., 100V 1,27 mm (.050")